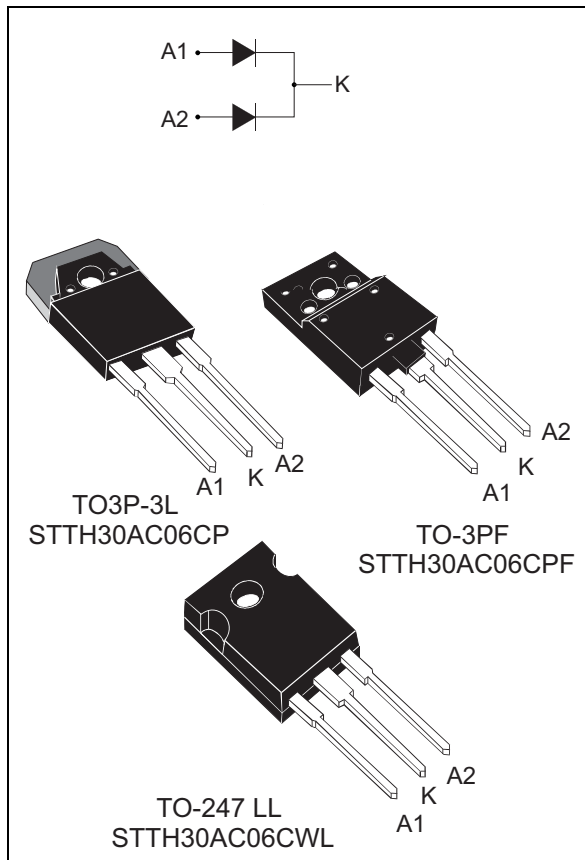


Turbo 2 ultrafast high voltage rectifier

Datasheet – production data



Description

The STTH30AC06C uses ST Turbo 2 600 V technology. It is suited as boost diode specially for use in air conditioning equipment as continuous mode interleaved power factor correction.

Table 1. Device summary

Symbol	Value
$I_{F(AV)}$	2 x 15A
V_{RRM}	600 V
t_{rr} (typ)	40 ns
V_F (typ)	1.15 V
T_j	175 °C

Features

- Ultrafast switching
- Low reverse current
- High thermal resistance
- Reduces switching and conduction losses
- Insulated package TO-3PF:
 - Insulated voltage: 2500 V DC

1 Characteristics

Table 2. Absolute ratings (limiting values per diode at 25 °C, unless otherwise specified)

Symbol	Parameter		Value	Unit
V_{RRM}	Repetitive peak reverse voltage		600	V
$I_{F(RMS)}$	Forward rms current		30	A
$I_{F(AV)}$	average forward current	Per diode	15	A
		Per device	30	
I_{FSM}	Surge non repetitive forward current	$t_p = 10$ ms sinusoidal	140	A
T_{stg}	Storage temperature range		-65 to +175	°C
T_j	Maximum operating junction temperature		175	°C

Table 3. Thermal parameters

Symbol	Parameter		Value	Unit
$R_{th(j-c)}$	Junction to case (TO3P-3L, TO247 LL)	Per diode	1.5	°C/W
		Total	0.85	
$R_{th(c)}$	Coupling (TO3P-3L, TO247 LL)		0.2	
$R_{th(j-c)}$	Junction to case (TO-3PF)	Per diode	3.5	
		Total	2.7	
$R_{th(c)}$	Coupling (TO-3PF)		1.9	

Table 4. Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
$I_R^{(1)}$	Reverse leakage current	$T_j = 25$ °C	$V_R = V_{RRM}$			10	µA
		$T_j = 150$ °C			40	400	
$V_F^{(2)}$	Forward voltage drop	$T_j = 25$ °C	$I_F = 15$ A			1.95	V
		$T_j = 150$ °C			1.15	1.45	
		$T_j = 25$ °C	$I_F = 30$ A			2.25	
		$T_j = 150$ °C			1.42	1.8	

1. Pulse test: $t_p = 5$ ms, $\delta < 2\%$
2. Pulse test: $t_p = 380$ µs, $\delta < 2\%$

To evaluate the conduction losses use the following equation:

$$P = 1.1 \times I_{F(AV)} + 0.023 I_{F(RMS)}^2$$

Table 5. Dynamic characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Typ.	Max.	Unit
t_{rr}	Reverse recovery time	$T_j = 25\text{ }^\circ\text{C}$	$I_F = 0.5\text{ A}, I_{rr} = 0.25\text{ A}, I_R = 1\text{ A}$			30	ns
			$I_F = 1\text{ A}, V_R = 30\text{ V}, dI_F/dt = 50\text{ A}/\mu\text{s}$		40	55	
I_{RM}	Reverse recovery current	$T_j = 125\text{ }^\circ\text{C}$	$I_F = 15\text{ A}, V_R = 400\text{ V}, dI_F/dt = 100\text{ A}/\mu\text{s}$		4	5.5	A
t_{fr}	Forward recovery time	$T_j = 25\text{ }^\circ\text{C}$	$I_F = 15\text{ A}, V_{FR} = 1.9\text{ V}, dI_F/dt = +100\text{ A}/\mu\text{s}$			100	ns
V_{FP}	Forward recovery voltage				2.5		V

Figure 1. Average forward power dissipation versus average forward current (per diode)

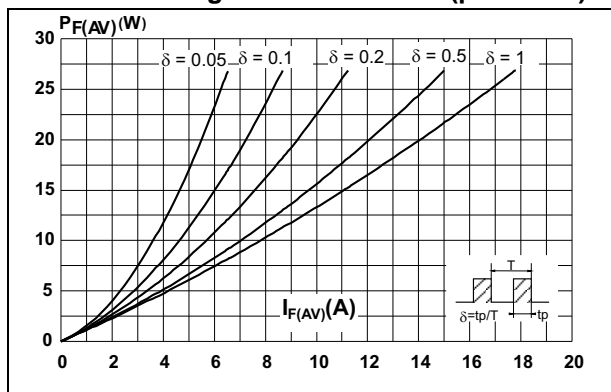


Figure 2. Forward voltage drop versus forward current (typical values, per diode)

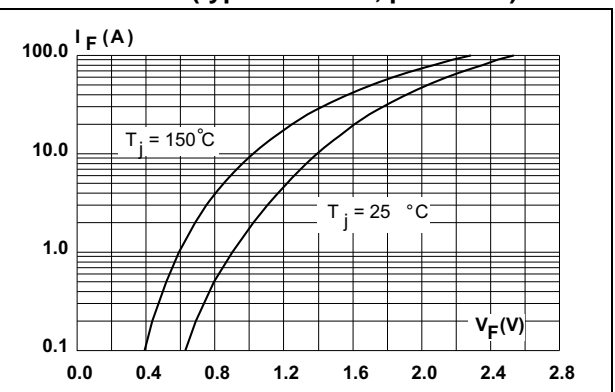


Figure 3. Forward voltage drop versus forward current (maximum values, per diode)

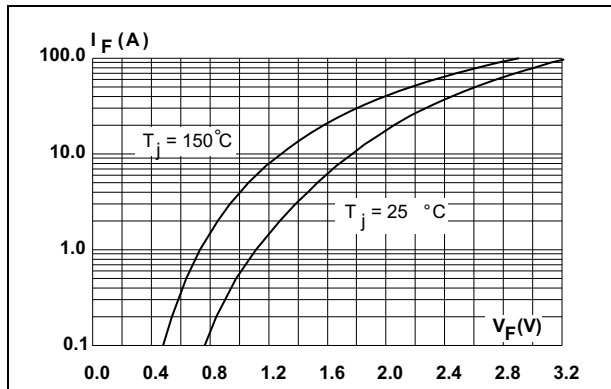


Figure 4. Relative variation of thermal impedance, junction to case, versus pulse duration (TO3P-3L, TO247 LL)

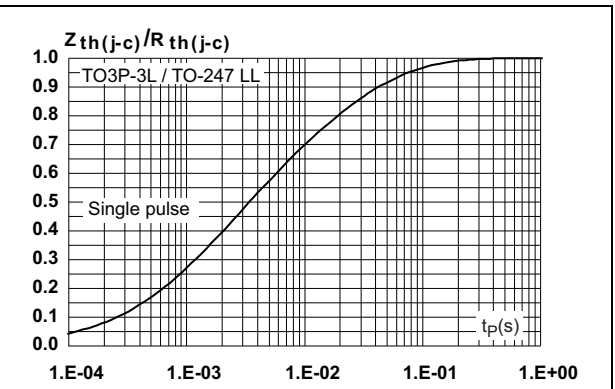


Figure 5. Relative variation of thermal impedance, junction to case, versus pulse duration (TO-3PF)

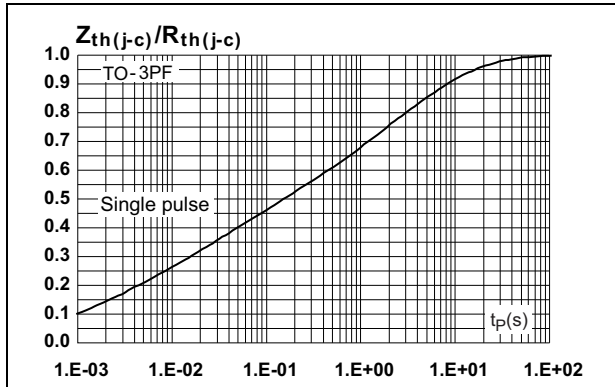


Figure 6. Peak reverse recovery current versus di_F/dt (typical values, per diode)

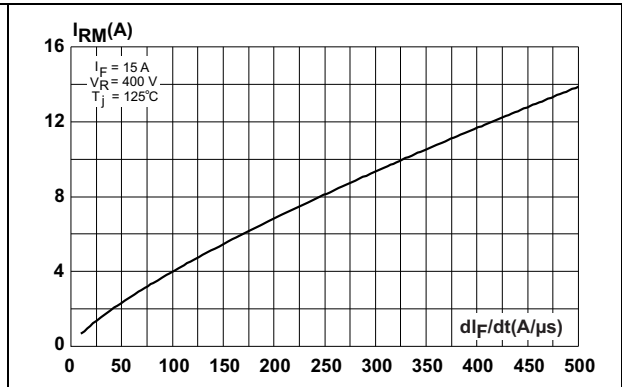


Figure 7. Reverse recovery time versus di_F/dt (typical values, per diode)

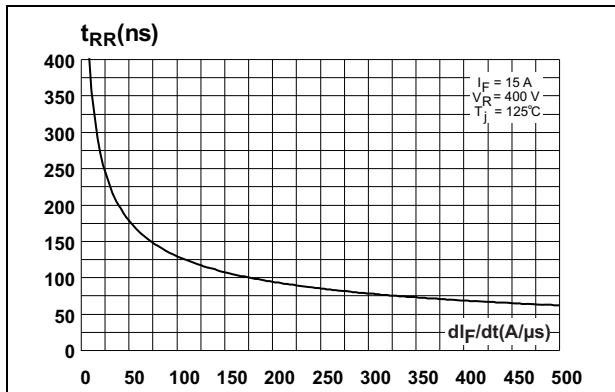


Figure 8. Reverse recovery charges versus di_F/dt (typical values, per diode)

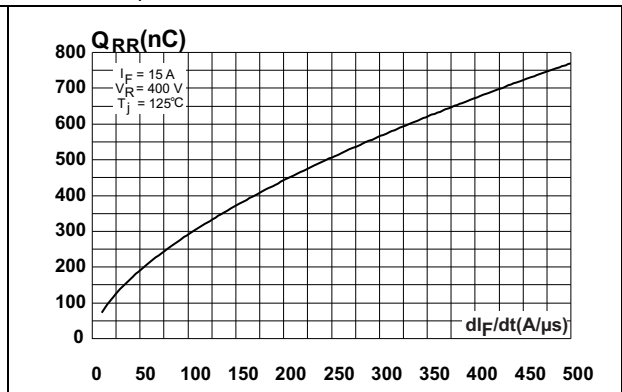


Figure 9. Reverse recovery softness factor versus di_F/dt (typical values, per diode)

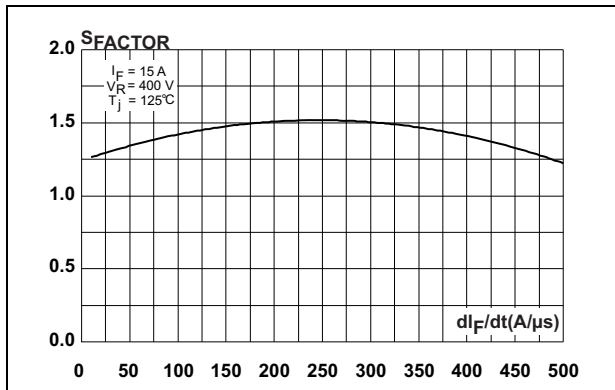


Figure 10. Relative variations of dynamic parameters versus junction temperature

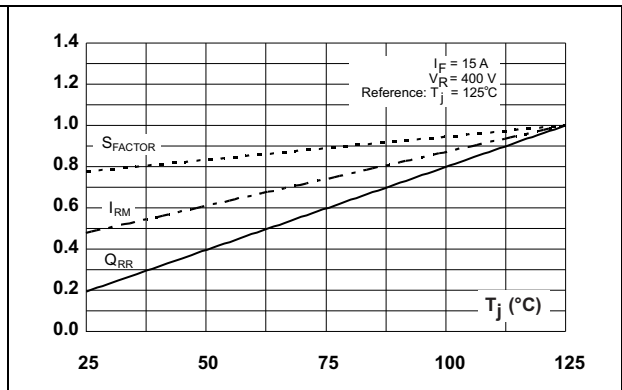


Figure 11. Transient peak forward voltage versus di_F/dt (typical values, per diode)

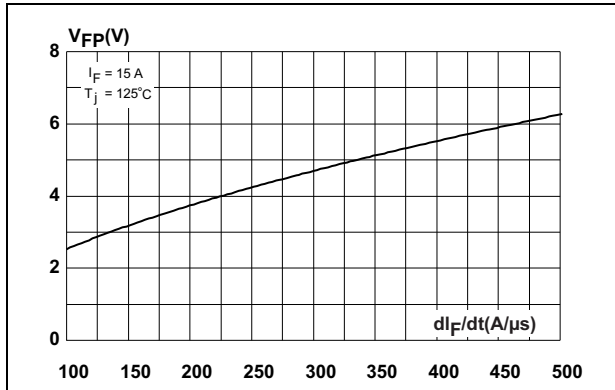


Figure 12. Forward recovery time versus di_F/dt (typical values, per diode)

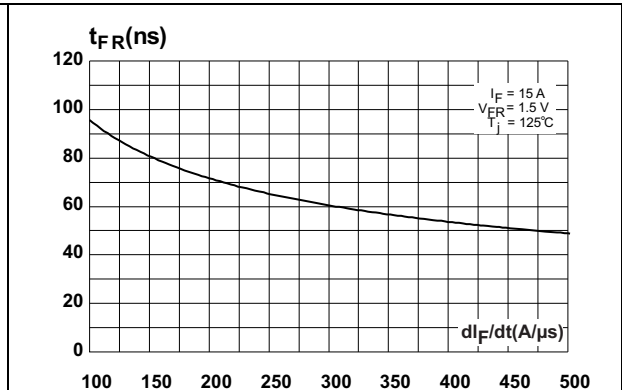
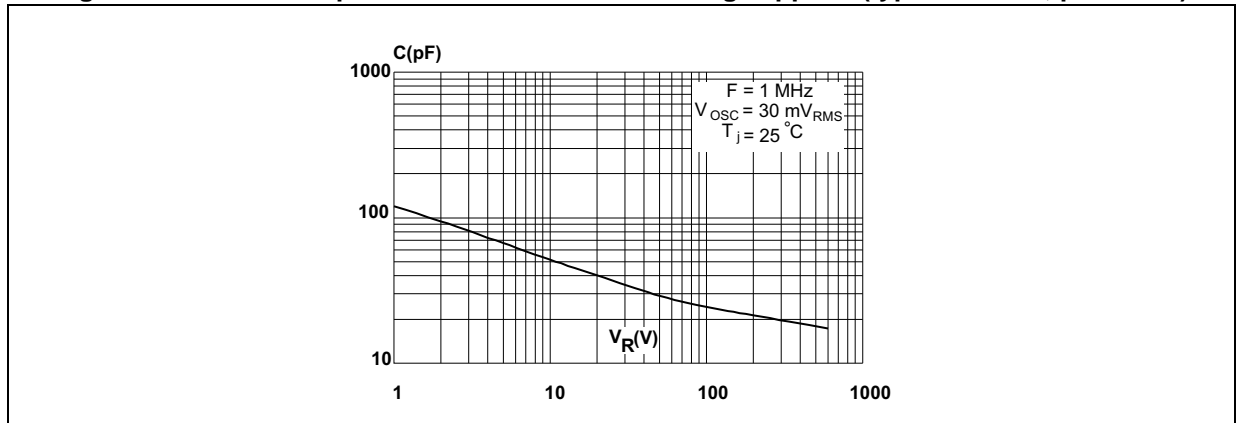


Figure 13. Junction capacitance versus reverse voltage applied (typical values, per diode)



2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque: 0.4 to 0.6 N·m
- Maximum torque value (T0-247 LL): 1.0 N·m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Figure 14. TO3P-3L dimension definitions

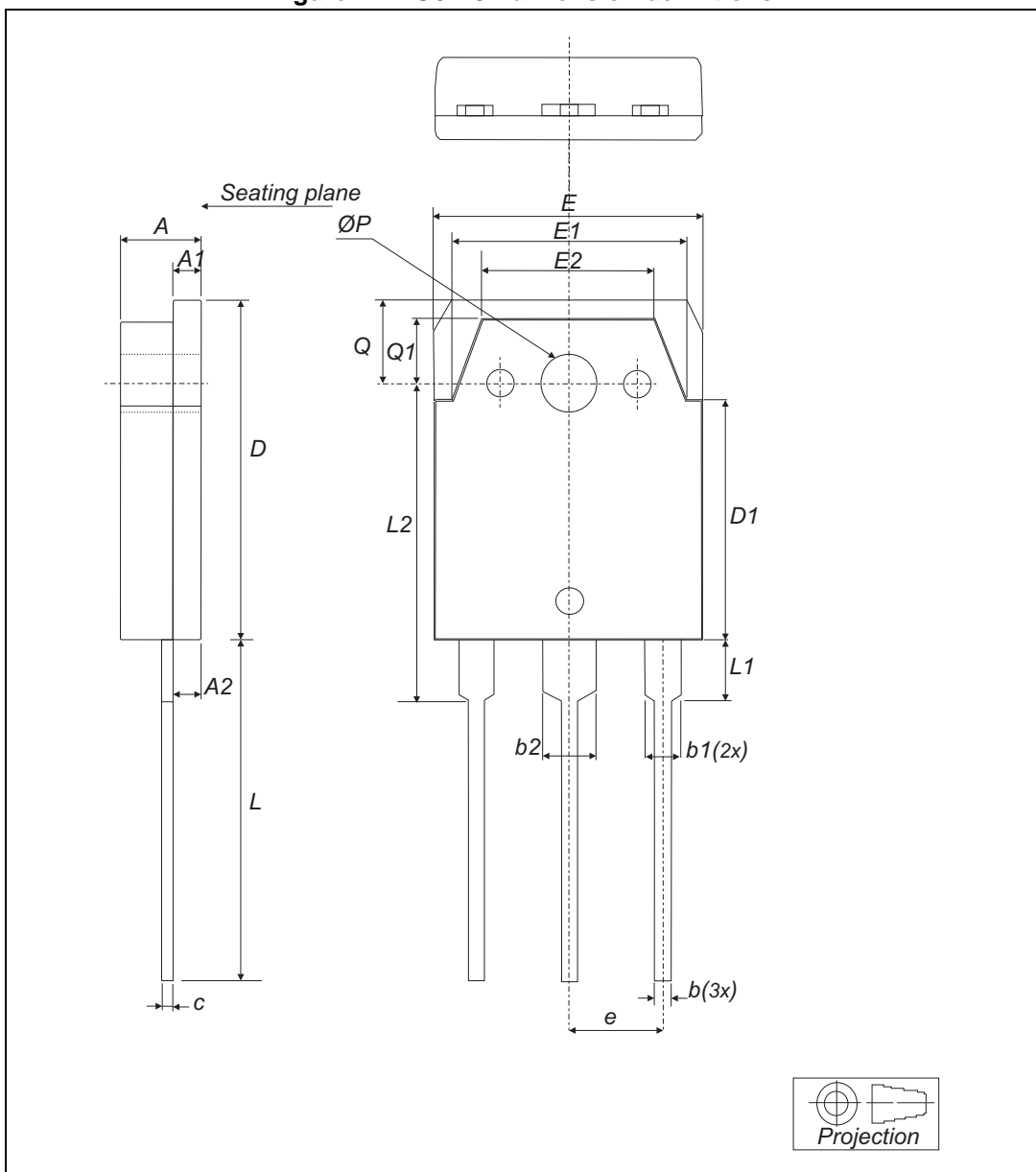


Table 6. TO3P-3L dimension values

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	4.6		5	0.18		0.19
A1	1.45	1.5	1.65	0.05	0.06	0.06
A2	1.20	1.40	1.60	0.04	0.05	0.06
b	0.80	1	1.20	0.03	0.04	0.05
b1	1.80		2.20	0.07		0.08
b2	2.80		3.20	0.11		0.12
c	0.55	0.60	0.75	0.02	0.02	0.03
D	19.70	19.90	20.10	0.77	0.78	0.79
D1		13.90			0.54	
E	15.40		15.80	0.60		0.62
E1		13.60			0.53	
E2		9.60			0.38	
e	5.15	5.45	5.75	0.20	0.21	0.22
L	19.50	20	20.50	0.76	0.78	0.80
L1		3.50			0.14	
L2	18.20	18.40	18.60	0.71	0.72	0.73
ØP	3.10		3.30	0.12		0.13
Q		5			0.19	
Q1		3.80			0.15	

Figure 15. TO-3PF dimension definitions

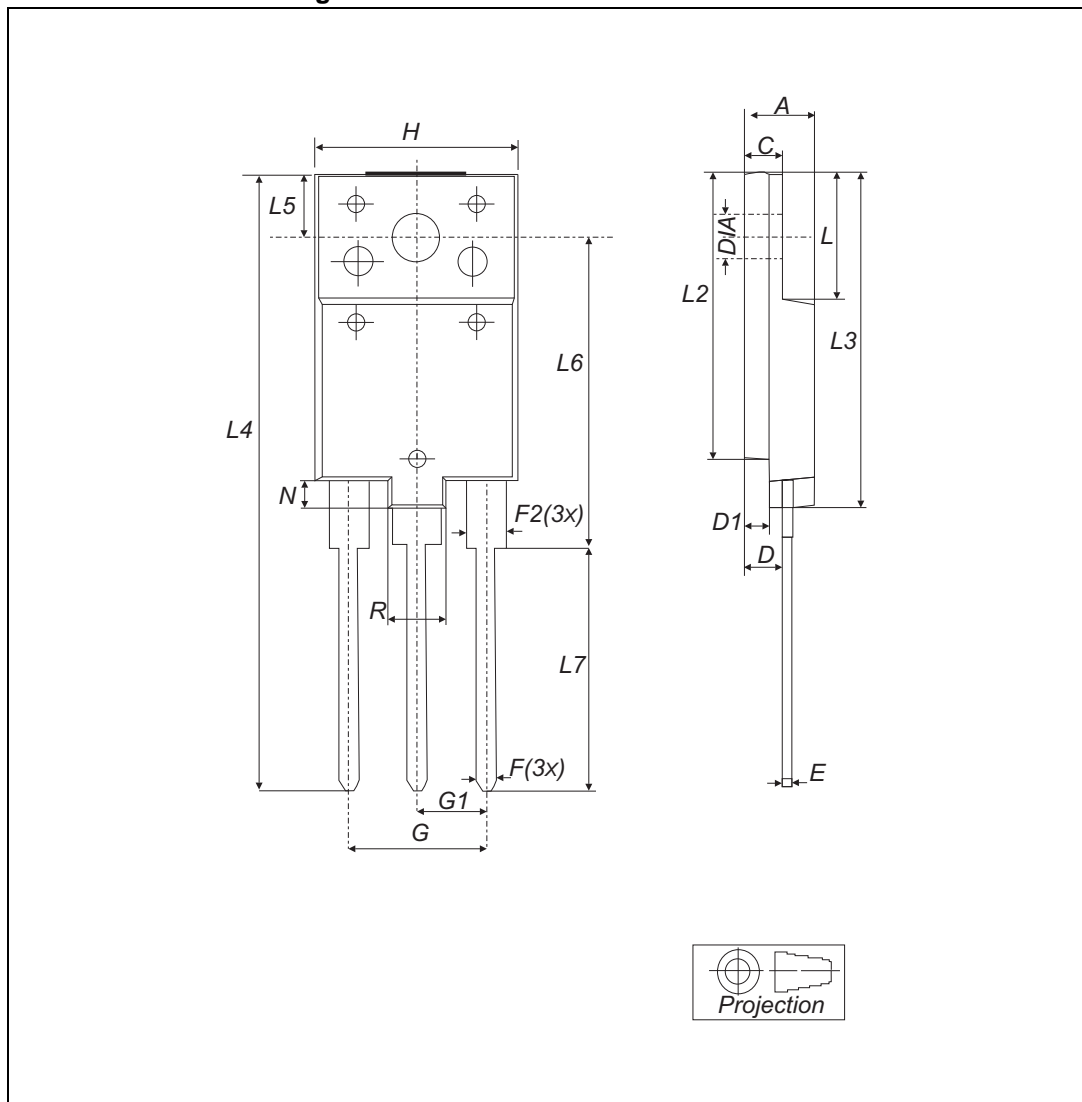


Table 7. TO-3PF dimension values

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	5.30		5.70	0.2		0.22
C	2.80		3.20	0.11		0.12
D	3.10		3.50	0.12		0.13
D1	1.80		2.20	0.07		0.08
E	0.80		1.10	0.03		0.04
F	0.65		0.95	0.025		0.037
F2	1.80		2.20	0.07		0.08
G	10.30		11.50	0.40		0.45
G1		5.45			0.21	
H	15.30		15.70	0.60		0.61
L	9.80	10	10.20	0.38	0.39	0.40
L2	22.20		22.80	0.87		0.90
L3	26.30		26.70	1.03		1.05
L4	43.20		44.40	1.70		1.74
L5	4.30		4.70	0.16		1.18
L6	24.30		24.70	0.95		0.97
L7	14.60		15	0.57		0.59
N	1.80		2.20	0.07		0.08
R	3.80		4.20	0.14		0.16
Dia	3.40		3.80	0.13		0.15

Figure 16. TO-247 LL dimension definitions

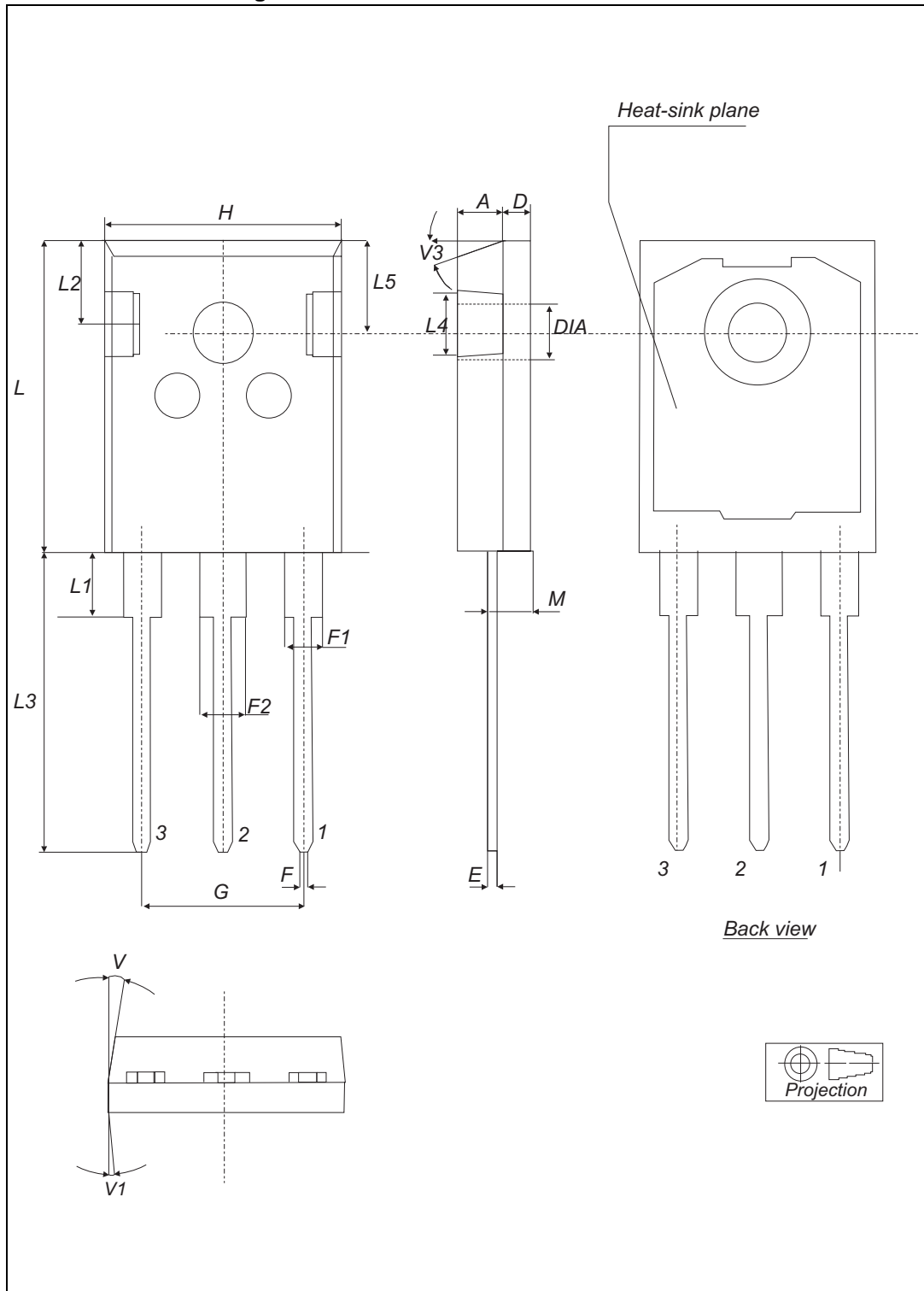


Table 8. TO-247 LL dimension values

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ	Max.
A	4.90		5.15	0.192		0.202
D	1.85		2.10	0.072		0.082
E	0.55		0.67	0.021		0.026
F	1.07		1.32	0.042		0.051
F1	1.90		2.38	0.074		0.093
F2	2.87		3.38	0.11		0.133
G	10.90 BSC			0.429 BSC		
H	15.77		16.02	0.62		0.63
L	20.82		21.07	0.81		0.82
L1	4.16		4.47	0.163		0.175
L2	5.49		5.74	0.216		0.225
L3	20.05		20.30	0.789		0.799
L4	3.68		3.93	0.144		0.154
L5	6.04		6.29	0.237		0.247
M	2.25		2.55	0.088		0.10
V		10°			10°	
V1		3°			3°	
V3		20°			20°	
∅	3.55		3.66	0.139		0.143

3 Ordering information

Table 9. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH30AC06CP	STTH30AC06CP	TO3P-3L	5.26	30	Tube
STTH30AC06CPF	TH30AC06C	TO-3PF	5.6	30	Tube
STTH30AC06CWL	STTH30AC06CWL	TO-247 LL	4.36	30	Tube

4 Revision history

Table 10. Document revision history

Date	Revision	Changes
13-Nov-2013	1	First release.

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